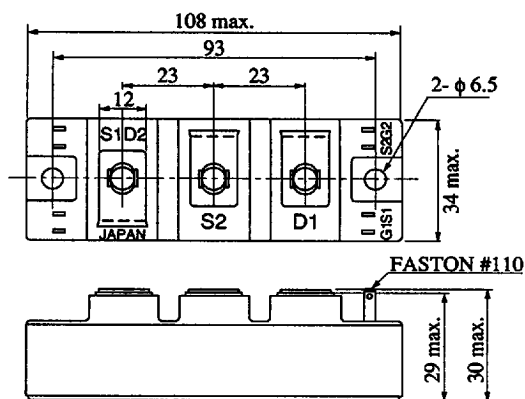


SILICON N-CHANNEL POWER MOS FET MODULE

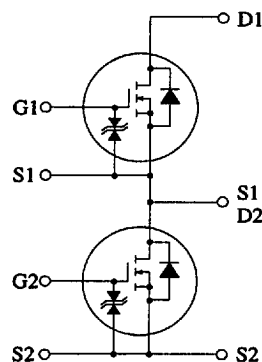
HIGH SPEED POWER SWITCHING

FEATURES

- Equipped with Power MOS FET
- Low On-Resistance
- High Speed Switching
- Low Drive Current
- Wide Area of Safe Operation
- Inherent Parallel Diode between Source and Drain
- Isolated Base from Terminal
- Suitable for Motor Driver, Switching Regulator and etc.



(Dimensions in mm)



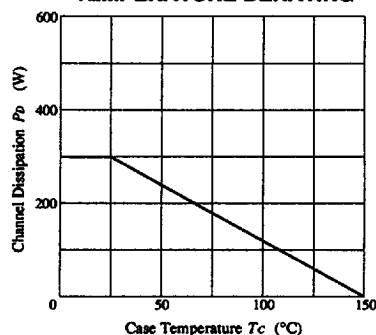
ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$) (Per FET chip)

Item	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current	I_D	50	A
Drain Peak Current	$I_{D(\text{peak})}$	120	A
Body-Drain Diode Reverse Drain Current	I_{DR}	50	A
Body-Drain Diode Reverse Drain Peak Current	$I_{DR(\text{peak})}$	120	A
Channel Dissipation	P_D^*	300	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	$-45 \sim +125$	$^\circ\text{C}$
Insulation Dielectric	V_{ul}^{**}	2000	V

* Value at $T_c = 25^\circ\text{C}$

** Base to Terminals AC minute

POWER VS. TEMPERATURE DERATING



HITACHI/(OPTOELECTRONICS)

■ELECTRICAL CHARACTERISTICS (Ta = 25°C) (Per FET chip)

Item	Symbol	Test Condition	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 10\text{mA}$, $V_{GS} = 0$	500	—	—	V
Gate-Source Leak Current	I_{GSS}	$V_{GS} = \pm 25\text{V}$, $V_{DS} = 0$	—	—	± 10	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 400\text{V}$, $V_{GS} = 0$	—	—	500	μA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$I_D = 1\text{mA}$, $V_{DS} = 10\text{V}$	2.0	—	3.0	V
Drain-Source Saturation Voltage	$V_{DS(on)}$	$I_D = 25\text{A}$, $V_{GS} = 10\text{V} *$	—	3.75	4.50	V
Static Drain-Source on State Resistance	$R_{DS(on)}$	$I_D = 25\text{A}$, $V_{GS} = 10\text{V} *$	—	0.15	0.18	Ω
Forward Transfer Admittance	$ y_{fs} $	$I_D = 25\text{A}$, $V_{DS} = 10\text{V} *$	18	30	—	S
Input Capacitance	C_{iss}	$V_{DS} = 10\text{V}$, $V_{GS} = 0$ $f = 1\text{MHz}$	—	5800	—	pF
Output Capacitance	C_{oss}		—	1550	—	pF
Reverse Transfer Capacitance	C_{rss}		—	170	—	pF
Turn-on Delay Time	$t_{d(on)}$	$I_D = 25\text{A}$, $V_{GS} = 10\text{V}$ $R_L = 1.2\Omega$	—	85	—	ns
Rise Time	t_r		—	400	—	ns
Turn-off Delay Time	$t_{d(off)}$		—	400	—	ns
Fall Time	t_f		—	340	—	ns
Body-Drain Diode Forward Voltage	V_{DF}	$I_F = 50\text{A}$, $V_{GS} = 0$	—	1.4	—	V
Body-Drain Diode Reverse Recovery Time	t_{rr}	$I_F = 50\text{A}$, $V_{GS} = 0$	—	130	—	ns

* Pulse Test

■MECHANICAL CHARACTERISTICS

Item	Symbol	Condition	Rating	Unit
Fixing Strength	—	Mounted into main-terminal with M5 screw	15~20	kg · cm
	—	Mounted into heat sink with M6 screw	20~30	kg · cm
Weight		Typical value	200	g